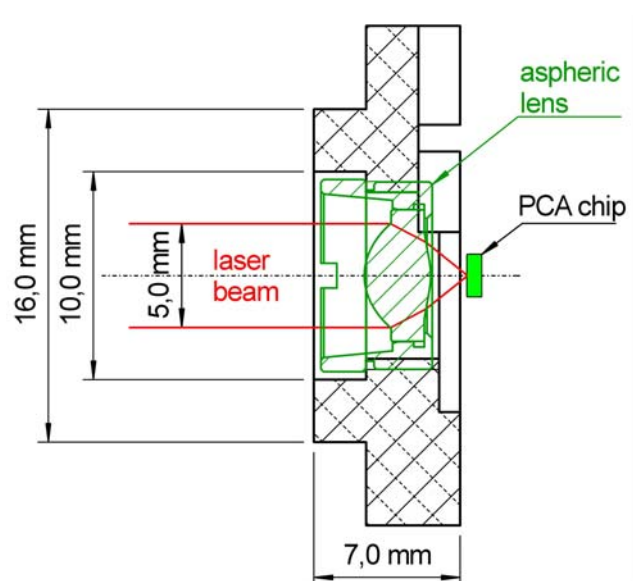
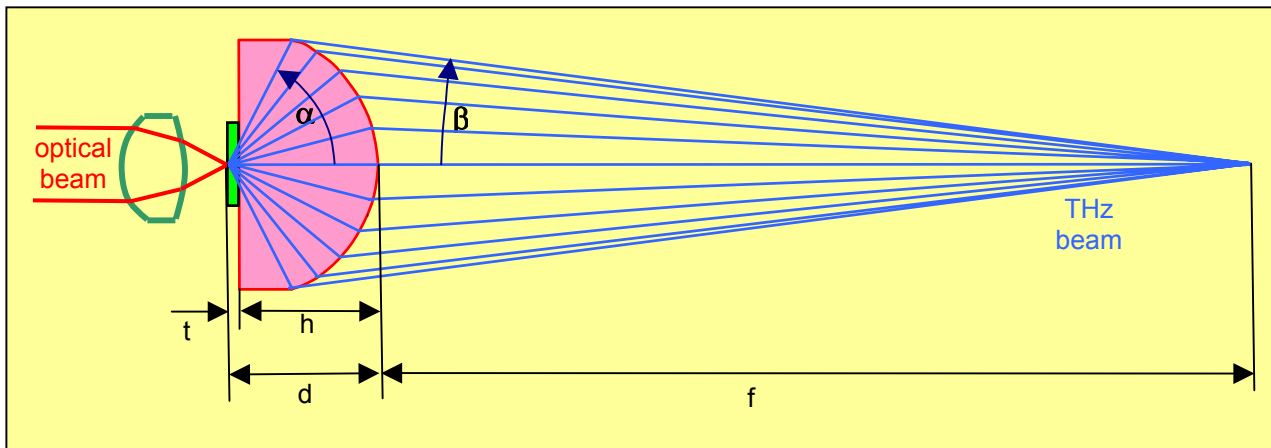


Mounted PCA on aspheric silicon substrate lens and optical lens
data sheet PCA-I-g-w- λ -a-I



Photoconductive antenna	substrate	semi-insulating GaAs
	chip area	2 mm x 2 mm or 6 mm x 6 mm
	thickness t	600 μ m
Aspheric THz lens	material	undoped HRFZ-silicon
	specific resistance ρ	>10 k Ω cm
	refractive index n	3.4
	diameter	12 mm
	height h	8 mm
	distance d	8.6 mm
	surface	rough antireflective
Terahertz beam	focal length f	50 mm
	collection angle α	57.6°
	convergence angle β	6.8°
Airy disc diameter	at 300 GHz	5 mm
	at 1 THz	1.5 mm
	at 3 THz	0.5 mm



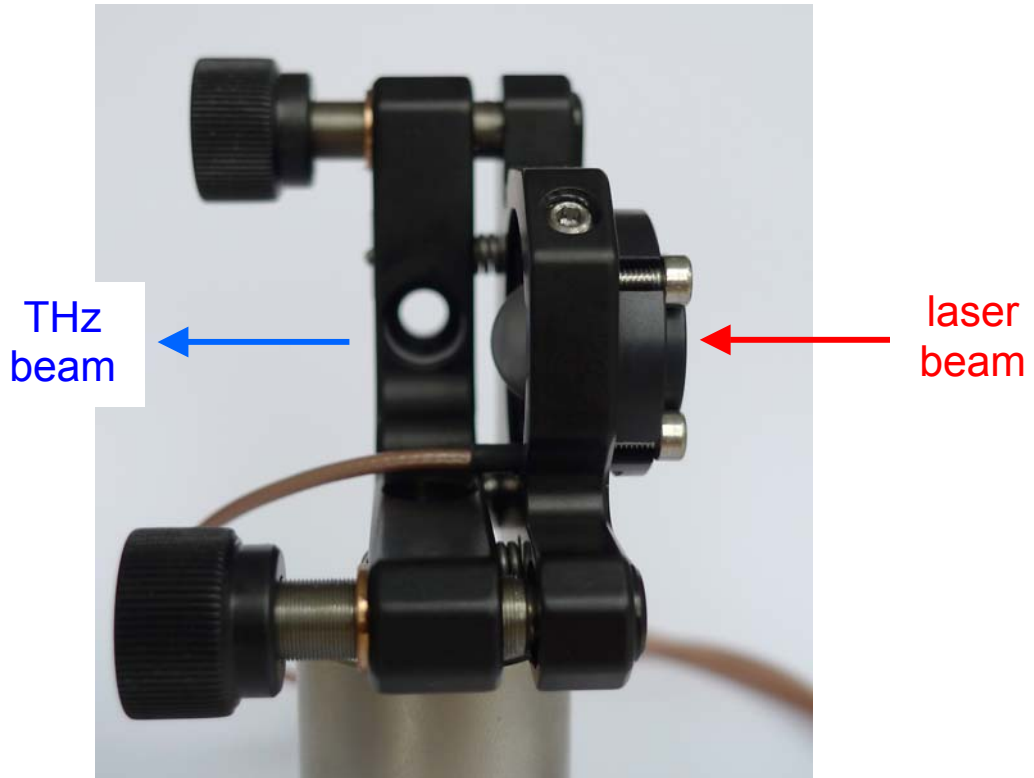
Aspheric optical lens

focal length	3.1 mm
free aperture	5 mm

Aluminum mount	25.4 mm diameter, 6 mm thick
Coaxial cable	type RG178 B/U, impedance 50Ω, capacitance 96pF/m, 1 m long
Connector type	BNC or SMA

- An adjusted optical aspheric lens focused the optical beam onto the PCA chip
- The PCA chip is glued on an aspheric focusing silicon substrate lens
- The silicon lens is glued on an aluminium mount
- The two antenna contacts are wire bonded on a printed circuit board, which provides the connection to a 1m long coaxial cable with BNC or SMA connector
- A central hole in the aluminium mount allows the Terahertz radiation to escape from the aspheric silicon lens as a collimated beam with a focus 50 mm away and an Airy disc diameter dependent on the THz frequency.

PCA with aspheric silicon lens, aspheric optical lens and coaxial cable

Front view on mounted aspheric optical lens
(laser side)Back view on aspheric silicon substrate lens
(THz side)